

**ELECOMP Capstone Design Program**

**Spring 2023 Semester**

***Summit Poster Submission- Format***

**Date & Time slot for sending: April 23<sup>rd</sup>, 2023; 8-9pm**

**Attach only ONE pdf document:**

**“Company Name-Summit-Poster”**

**Here is the format: (follow carefully!!)**

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**To: .....(email addresses of TDs, Consulting TDs)**

**CC: [sunak@ele.uri.edu](mailto:sunak@ele.uri.edu), ....., ..... (all team members, including self)**

**From: ..... (one team member)**

**Subject: ELECOMP Capstone: Final Poster for the Summit.**

**Content: Message to TDs. (Copy and paste)**

Dear Technical Directors:

We have attached the Final Poster, which will be posted on the program website on May 9<sup>th</sup>, 2023, the date for the Summit. The information used was approved previously by you, in the TPS#23, sent to you on April 18<sup>th</sup>, 2023.

Yours sincerely,

Name: Capstone Designer 1

Name: Capstone Designer 2

(add more designers, as needed)